



14-Bit, Dual, Parallel Input, Multiplying Digital-to-Analog Converter

FEATURES

- $\pm 0.5\text{LSB DNL}$
- $\pm 0.5\text{LSB INL}$
- **Low Noise:** $12\text{nV}/\sqrt{\text{Hz}}$
- **Low Power:** $I_{\text{DD}} = 1\mu\text{A}$ per channel at 2.7V
- **2mA Full-Scale Current, with $V_{\text{REF}} = 10\text{V}$**
- **Settling Time:** $0.5\mu\text{s}$
- **14-Bit Monotonic**
- **4-Quadrant Multiplying Reference Inputs**
- **Reference Bandwidth:** 10MHz
- **Reference Input:** $\pm 18\text{V}$
- **Reference Dynamics:** -105 THD
- **Midscale or Zero Scale Reset**
- **Analog Power Supply:** $+2.7\text{V}$ to $+5.5\text{V}$
- **TSSOP-38 Package**
- **Industry-Standard Pin Configuration**
- **Pin Compatible with the 16-Bit [DAC8822](#)**
- **Temperature Range:** -40°C to $+125^\circ\text{C}$

APPLICATIONS

- **Automatic Test Equipment**
- **Instrumentation**
- **Digitally Controlled Calibration**
- **Industrial Control PLCs**

DESCRIPTION

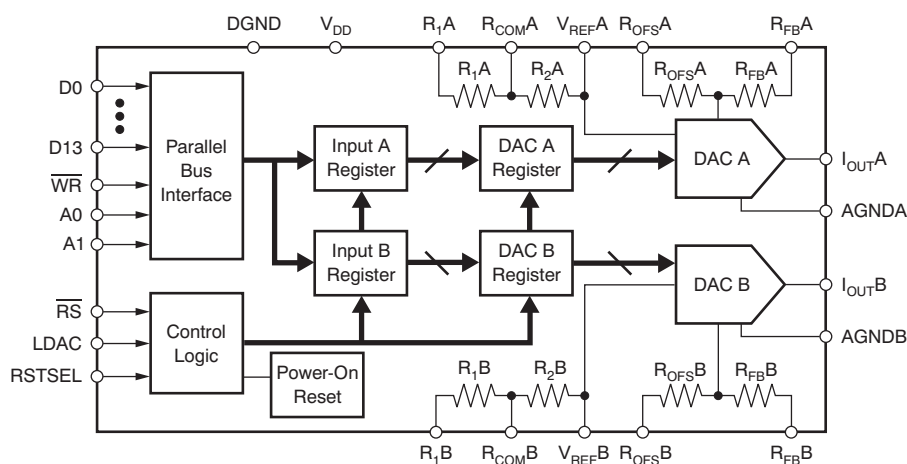
The DAC8805 dual, multiplying digital-to-analog converter (DAC) is designed to operate from a single 2.7V to 5.5V supply.

The applied external reference input voltage V_{REF} determines the full-scale output current. An internal feedback resistor (R_{FB}) provides temperature tracking for the full-scale output when combined with an external, current-to-voltage (I/V) precision amplifier.

A RSTSEL pin allows system reset assertion ($\overline{\text{RS}}$) to force all registers to zero code when RSTSEL = '0', or to mid-scale code when RSTSEL = '1'. Additionally, an internal power-on reset forces all registers to zero or mid-scale code at power-up, depending on the state of the RSTSEL pin.

A parallel interface offers high-speed communications. The DAC8805 is packaged in a space-saving TSSOP-38 package and has an industry-standard pinout. The device is specified from -40°C to $+125^\circ\text{C}$.

For a 16-bit, pin-compatible version, see the [DAC8822](#).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION⁽¹⁾

| PRODUCT | RELATIVE ACCURACY (LSB) | DIFFERENTIAL NONLINEARITY (LSB) | PACKAGE-LEAD (DESIGNATOR) | SPECIFIED TEMPERATURE RANGE | PACKAGE MARKING |
|----------|-------------------------|---------------------------------|---------------------------|-----------------------------|-----------------|
| DAC8805Q | ±1 | ±1 | TSSOP-38 (DBT) | –40°C to +125°C | DAC8805 |

(1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | | DAC8805 | UNIT |
|---|----------------------------|---|------|
| V _{DD} to GND | | –0.3 to +7 | V |
| Digital input voltage to GND | | –0.3 to +V _{DD} + 0.3 | V |
| V (I _{OUT}) to GND | | –0.3 to +V _{DD} + 0.3 | V |
| REF, R _{OFS} , R _{FB} , R ₁ , R _{COM} to AGND, DGND | | ±25 | V |
| Operating temperature range | | –40 to +125 | °C |
| Storage temperature range | | –65 to +150 | °C |
| Junction temperature range (T _J max) | | +150 | °C |
| Power dissipation | | (T _J max – T _A) / R _{θJA} | W |
| Thermal impedance, R _{θJA} | | 53 | °C/W |
| ESD rating | Human Body Model (HBM) | 4000 | V |
| | Charged Device Model (CDM) | 500 | V |

(1) Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. Exposure to absolute maximum conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

All specifications at $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$, $V_{DD} = +2.7\text{V}$ to $+5.5\text{V}$, $I_{OUT} = \text{virtual GND}$, $\text{GND} = 0\text{V}$, and $V_{REF} = 10\text{V}$, unless otherwise noted.

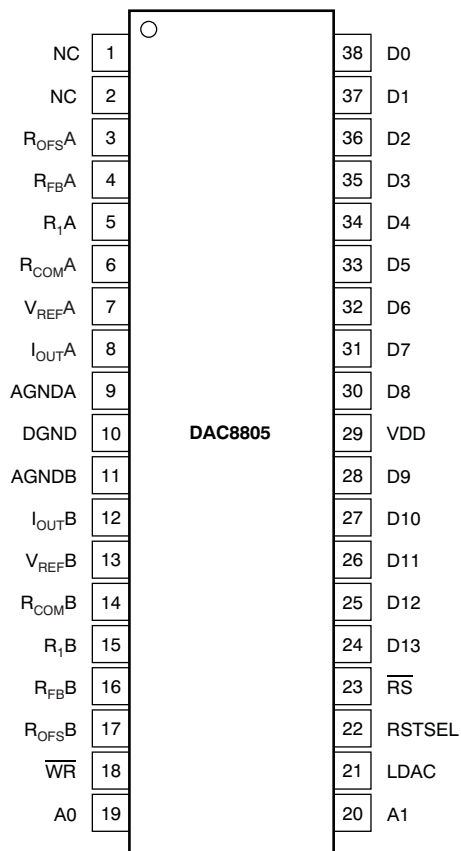
| PARAMETER | CONDITIONS | DAC8805 | | | UNITS | |
|--|---|---|-----------|-----------|------------------------|------------|
| | | MIN | TYP | MAX | | |
| STATIC PERFORMANCE | | | | | | |
| Resolution | | 14 | | | Bits | |
| Relative accuracy | INL | | ± 0.5 | ± 1 | LSB | |
| Differential nonlinearity | DNL | | ± 0.5 | ± 1 | LSB | |
| Output leakage current | Data = 0000h, $T_A = +25^\circ\text{C}$ | | | 10 | nA | |
| Output leakage current | Data = 0000h, Full temperature range | | | 20 | nA | |
| Full-scale gain error | Unipolar, data = 3FFFh | | ± 1 | ± 4 | mV | |
| | Bipolar, data = 3FFFh | | ± 1 | ± 4 | mV | |
| Full-scale temperature coefficient | | | ± 1 | ± 2 | ppm/ $^\circ\text{C}$ | |
| Bipolar zero error | $T_A = +25^\circ\text{C}$ | | ± 1 | ± 3 | mV | |
| | Full temperature range | | ± 1 | ± 3 | mV | |
| Power-supply rejection ratio | PSRR $V_{DD} = 5\text{V} \pm 10\%$ | | ± 0.1 | ± 0.5 | LSB/V | |
| OUTPUT CHARACTERISTICS⁽¹⁾ | | | | | | |
| Output current | | | 2 | | mA | |
| Output capacitance | Code dependent | | 50 | | pF | |
| REFERENCE INPUT | | | | | | |
| Reference voltage range | V_{REF} | | -18 | 18 | V | |
| Input resistance (unipolar) | R_{REF} | | 4 | 5 | 6 | k Ω |
| Input capacitance | | | 5 | | pF | |
| R_1, R_2 | | | 4 | 5 | 6 | k Ω |
| Feedback and offset resistance | R_{OFS}, R_{FB} | | 8 | 10 | 12 | k Ω |
| LOGIC INPUTS AND OUTPUT⁽¹⁾ | | | | | | |
| Input low voltage | V_{IL} | $V_{DD} = +2.7\text{V}$ | | 0.6 | V | |
| | V_{IL} | $V_{DD} = +5\text{V}$ | | 0.8 | V | |
| Input high voltage | V_{IH} | $V_{DD} = +2.7\text{V}$ | 2.1 | | V | |
| | V_{IH} | $V_{DD} = +5\text{V}$ | 2.4 | | V | |
| Input leakage current | I_{IL} | | 0.001 | 1 | μA | |
| Input capacitance | C_{IL} | | | 8 | pF | |
| POWER REQUIREMENTS | | | | | | |
| Supply voltage | V_{DD} | | 2.7 | 5.5 | V | |
| Supply current | I_{DD} | Normal operation, logic inputs = 0V | 3 | 6 | μA | |
| $V_{DD} = +4.5\text{V}$ to $+5.5\text{V}$ | | $V_{IH} = V_{DD}$ and $V_{IL} = \text{GND}$ | 3 | 6 | μA | |
| $V_{DD} = +2.7\text{V}$ to $+3.6\text{V}$ | | $V_{IH} = V_{DD}$ and $V_{IL} = \text{GND}$ | 1 | 3 | μA | |
| AC CHARACTERISTICS⁽¹⁾⁽²⁾ | | | | | | |
| Output current settling time | t_s | To 0.1% of full-scale, Data = 0000h to 3FFFh to 0000h | 0.3 | | μs | |
| | t_s | To 0.006% of full-scale, Data = 0000h to 3FFFh to 0000h | 0.5 | | μs | |
| Reference multiplying BW | BW – 3dB | $V_{REF} = 5V_{PP}$, Data = 3FFFh, 2-quadrant mode | 10 | | MHz | |
| DAC glitch impulse | | $V_{REF} = 0\text{V}$ to 10V , Data = 1FFFh to 2000h to 1FFFh | 5 | | nV–s | |
| Feedthrough error | V_{OUT}/V_{REF} | Data = 0000h, $V_{REF} = 100\text{kHz}$, $\pm 10V_{PP}$, 2-quadrant mode | -70 | | dB | |
| Crosstalk error | V_{OUT}/V_{REFB} | Data = 0000h, $V_{REFB} = 100mV_{RMS}$, $f = 100\text{kHz}$ | -100 | | dB | |
| Digital feedthrough | | LDAC = Logic low, $V_{REF} = -10\text{V}$ to $+10\text{V}$ Any code change | 1 | | nV–s | |
| Total harmonic distortion | THD | $V_{REF} = 6V_{RMS}$, Data = 3FFFh, $f = 1\text{kHz}$ | -105 | | dB | |
| Output noise density | e_N | $f = 1\text{kHz}$, BW = 1Hz, 2-quadrant mode | 12 | | nV/ $\sqrt{\text{Hz}}$ | |

(1) Specified by design and characterization; not production tested.

(2) All ac characteristic tests are performed in a closed-loop system using a THS4011 I-to-V converter amplifier.

PIN ASSIGNMENTS

**DBT PACKAGE
TSSOP-38
(TOP VIEW)**



PIN ASSIGNMENTS (continued)
Table 1. TERMINAL FUNCTIONS

| PIN # | NAME | DESCRIPTION |
|--------------|--------------------|---|
| 1, 2 | NC | No connection |
| 3 | R _{OFS} A | Bipolar Offset Resistor A. Accepts up to ±18V. In 2-quadrant mode, R _{OFS} A ties to R _{FB} A. In 4-quadrant mode, R _{OFS} A ties to R ₁ A and the external reference. |
| 4 | R _{FB} A | Internal Matching Feedback Resistor A. Connects to the external op amp for I-V conversion. |
| 5 | R ₁ A | 4-Quadrant Resistor. In 2-quadrant mode, R ₁ A shorts to the V _{REF} A pin. In 4-quadrant mode, R ₁ A ties to R _{OFS} A and the reference input. |
| 6 | R _{COM} A | Center Tap Point of the Two 4-Quadrant Resistors, R ₁ A and R ₂ A. In 2-quadrant mode, R _{COM} A shorts to the V _{REF} pin. In 4-quadrant mode, R _{COM} A ties to the inverting node of the reference amplifier. |
| 7 | V _{REF} A | DAC A Reference Input in 2-Quadrant Mode, R ₂ Terminal in 4-Quadrant Mode. In 2-quadrant mode, V _{REF} A is the reference input with constant input resistance versus code. In 4-quadrant mode, V _{REF} A is driven by the external reference amplifier. |
| 8 | I _{OUT} A | DAC A Current Output. Connects to the inverting terminal of external precision I-V op amp for voltage output. |
| 9 | AGNDA | DAC A Analog Ground. |
| 10 | DGND | Digital Ground. |
| 11 | AGNDB | DAC B Analog Ground. |
| 12 | I _{OUT} B | DAC B Current Output. Connects to the inverting terminal of external precision I-V op amp for voltage output. |
| 13 | V _{REF} B | DAC B Reference Input in 2-Quadrant Mode, R ₂ Terminal in 4-Quadrant Mode. In 2-quadrant mode, V _{REF} B is the reference input with constant input resistance versus code. In 4-quadrant mode, V _{REF} B is driven by the external reference amplifier. |
| 14 | R _{COM} B | Center Tap Point of the Two 4-Quadrant Resistors, R ₁ B and R ₂ B. In 2-quadrant mode, R _{COM} B shorts to the V _{REF} pin. In 4-quadrant mode, R _{COM} B ties to the inverting node of the reference amplifier. |
| 15 | R ₁ B | 4-Quadrant Resistor. In 2-quadrant mode, R ₁ B shorts to the V _{REF} B pin. In 4-quadrant mode, R ₁ B ties to R _{OFS} B and the reference input. |
| 16 | R _{FB} B | Internal Matching Feedback Resistor B. Connects to external op amp for I-V conversion. |
| 17 | R _{OFS} B | Bipolar Offset Resistor B. Accepts up to ±18V. In 2-quadrant mode, R _{OFS} B ties to R _{FB} B. In 4-quadrant mode, R _{OFS} B ties to R ₁ B and the external reference. |
| 18 | \overline{WR} | Write Control Digital Input In, Active Low. \overline{WR} enables input registers. Signal level must be $\leq V_{DD} + 0.3V$. |
| 19 | A0 | Address 0. Signal level must be $\leq V_{DD} + 0.3V$. |
| 20 | A1 | Address 1. Signal level must be $\leq V_{DD} + 0.3V$. |
| 21 | LDAC | Digital Input Load DAC Control. Signal level must be $\leq V_{DD} + 0.3V$. See the Function of Control Inputs table for details. |
| 22 | RSTSEL | Power-On Reset State. RSTSEL = 0 corresponds to zero-scale reset. RSTSEL = 1 corresponds to mid-scale reset. The signal level must be $\leq V_{DD} + 0.3V$. |
| 23 | \overline{RS} | Reset. Active low resets both input and DAC registers. Resets to zero-scale if RSTSEL = 0, and to mid-scale if RSTSEL = 1. Signal level must be equal to or less than $V_{DD} + 0.3V$. |
| 24-28, 30-38 | D0-D13 | Digital Input Data Bits D0 to D13. Signal level must be $\leq V_{DD} + 0.3V$. D13 is MSB. |
| 29 | V _{DD} | Positive Power Supply Input. The specified range of operation is 2.7V to 5.5V. |

TIMING AND FUNCTIONAL INFORMATION

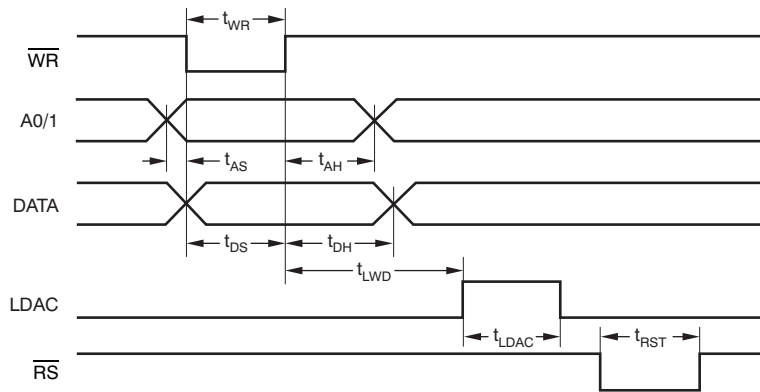


Figure 1. Timing Diagram

TIMING CHARACTERISTICS



All specifications at $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$, $I_{OUT} = \text{virtual GND}$, $\text{GND} = 0\text{V}$, and $V_{REF} = 10\text{V}$, unless otherwise noted

| PARAMETER | CONDITIONS | DAC8805 | | | UNITS |
|------------------------------------|-------------------------|---------|-----|-----|-------|
| | | MIN | TYP | MAX | |
| Data to \overline{WR} setup time | $V_{DD} = +5.0\text{V}$ | 10 | | | ns |
| | $V_{DD} = +2.7\text{V}$ | 10 | | | ns |
| A0/1 to \overline{WR} setup time | $V_{DD} = +5.0\text{V}$ | 10 | | | ns |
| | $V_{DD} = +2.7\text{V}$ | 10 | | | ns |
| Data to \overline{WR} hold time | $V_{DD} = +5.0\text{V}$ | 0 | | | ns |
| | $V_{DD} = +2.7\text{V}$ | 0 | | | ns |
| A0/1 to \overline{WR} hold time | $V_{DD} = +5.0\text{V}$ | 0 | | | ns |
| | $V_{DD} = +2.7\text{V}$ | 0 | | | ns |
| \overline{WR} pulse width | $V_{DD} = +5.0\text{V}$ | 10 | | | ns |
| | $V_{DD} = +2.7\text{V}$ | 10 | | | ns |
| LDAC pulse width | $V_{DD} = +5.0\text{V}$ | 10 | | | ns |
| | $V_{DD} = +2.7\text{V}$ | 10 | | | ns |
| \overline{RS} pulse width | $V_{DD} = +5.0\text{V}$ | 10 | | | ns |
| | $V_{DD} = +2.7\text{V}$ | 10 | | | ns |
| \overline{WR} to LDAC delay time | $V_{DD} = +5.0\text{V}$ | 0 | | | ns |
| | $V_{DD} = +2.7\text{V}$ | 0 | | | ns |

Table 2. Address Decoder Pins

| A1 | A0 | OUTPUT UPDATE |
|----|----|-----------------|
| 0 | 0 | DAC A |
| 0 | 1 | None |
| 1 | 0 | DAC A and DAC B |
| 1 | 1 | DAC B |

Table 3. Function of Control Inputs

| CONTROL INPUTS | | | REGISTER OPERATION |
|-----------------|---|---|---|
| \overline{RS} | \overline{WR} | LDAC | |
| 0 | X | X | Asynchronous operation. Reset the input and DAC register to '0' when the RSTSEL pin is tied to DGND, and to midscale when RSTSEL is tied to V_{DD} . |
| 1 | 0 | 0 | Load the input register with all 14 data bits. |
| 1 | 1 | 1 | Load the DAC register with the contents of the input register. |
| 1 | 0 | 1 | The input and DAC register are transparent. |
| 1 |  |  | LDAC and \overline{WR} are tied together and programmed as a pulse. The 14 data bits are loaded into the input register on the falling edge of the pulse and then loaded into the DAC register on the rising edge of the pulse. |
| 1 | 1 | 0 | No register operation. |

TYPICAL CHARACTERISTICS: $V_{DD} = +5V$

Channel A

LINEARITY ERROR
vs DIGITAL INPUT CODE

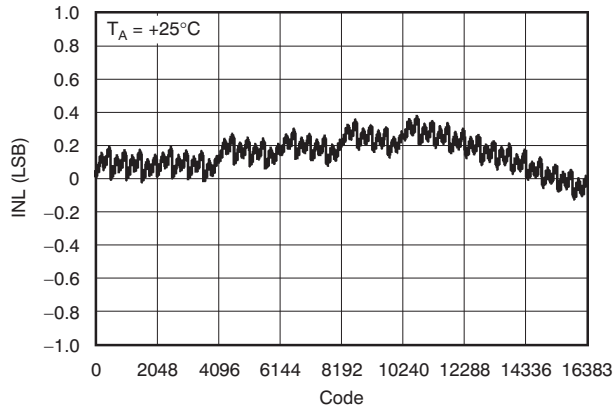


Figure 2.

DIFFERENTIAL LINEARITY ERROR
vs DIGITAL INPUT CODE

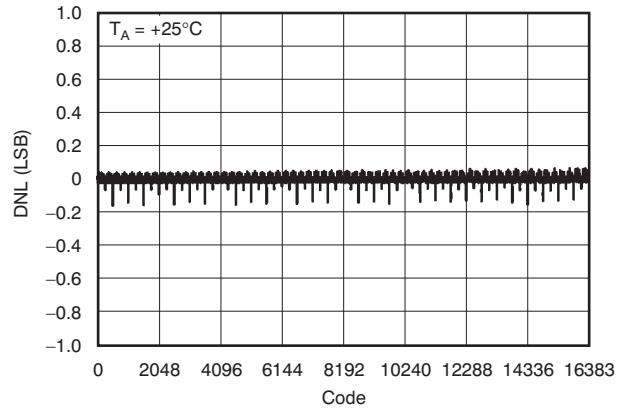


Figure 3.

LINEARITY ERROR
vs DIGITAL INPUT CODE

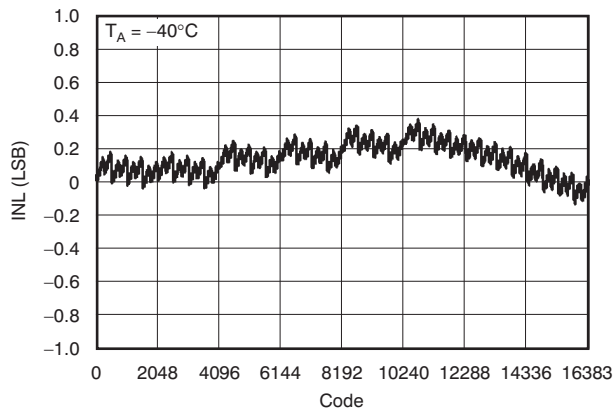


Figure 4.

DIFFERENTIAL LINEARITY ERROR
vs DIGITAL INPUT CODE

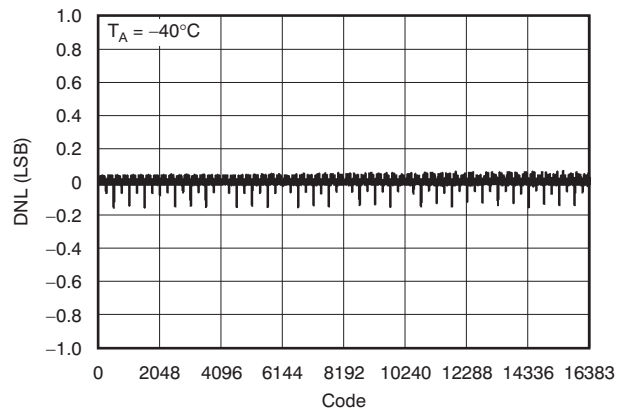


Figure 5.

LINEARITY ERROR
vs DIGITAL INPUT CODE

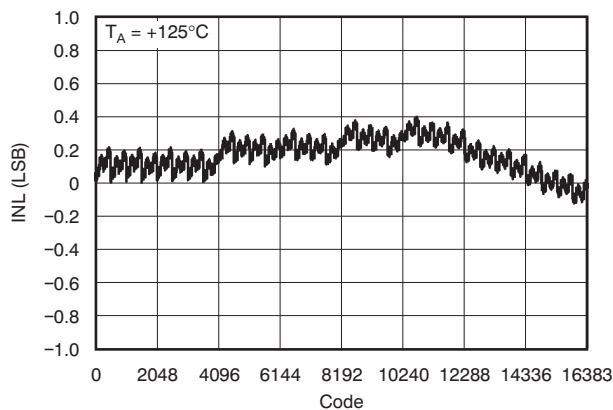


Figure 6.

DIFFERENTIAL LINEARITY ERROR
vs DIGITAL INPUT CODE

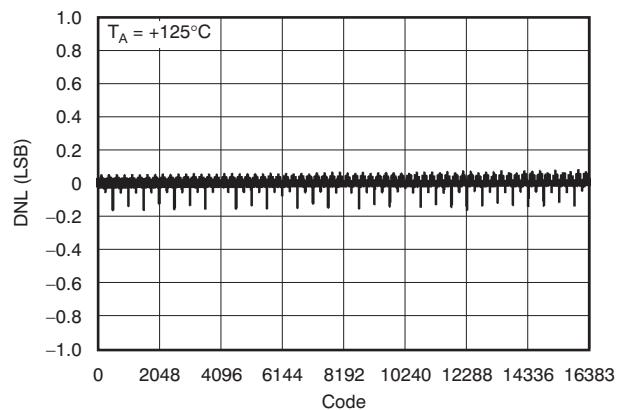


Figure 7.

TYPICAL CHARACTERISTICS: $V_{DD} = +5V$ (continued)

Channel B

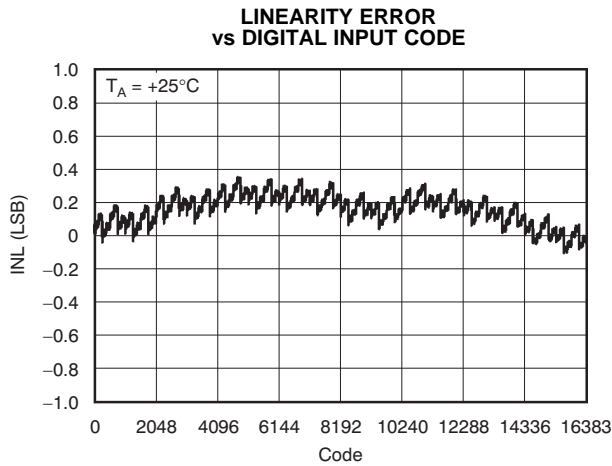


Figure 8.

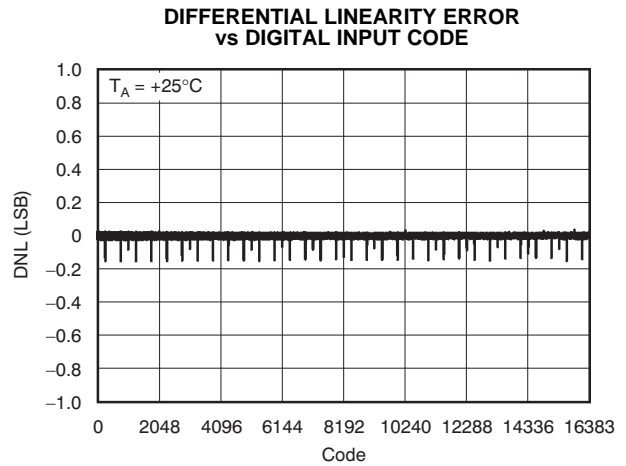


Figure 9.

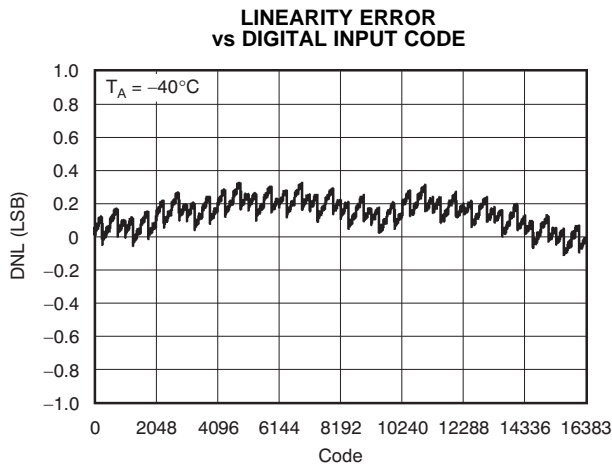


Figure 10.

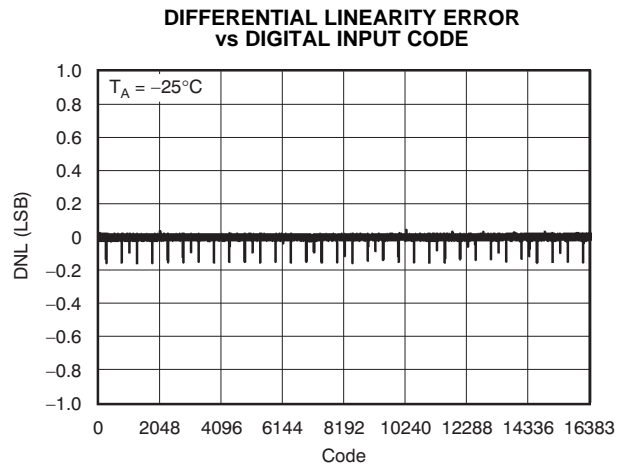


Figure 11.

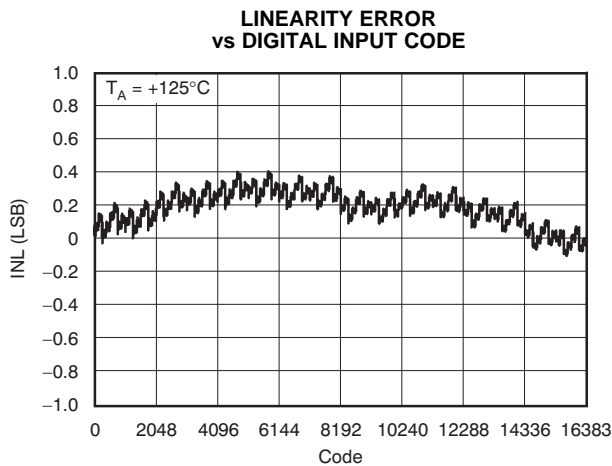


Figure 12.

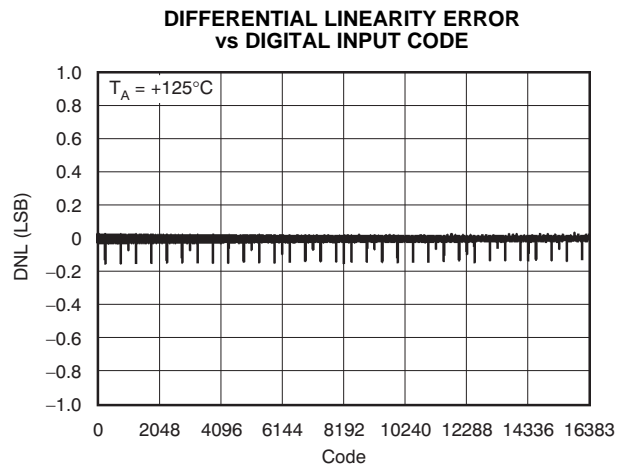


Figure 13.

TYPICAL CHARACTERISTICS: $V_{DD} = +5V$ (continued)

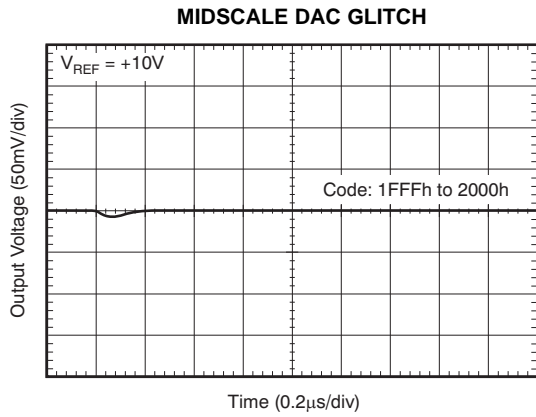


Figure 14.

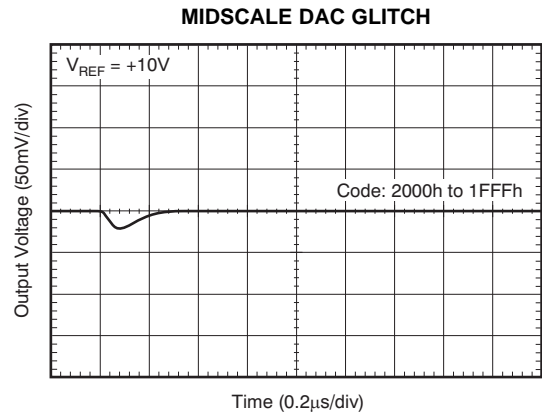


Figure 15.

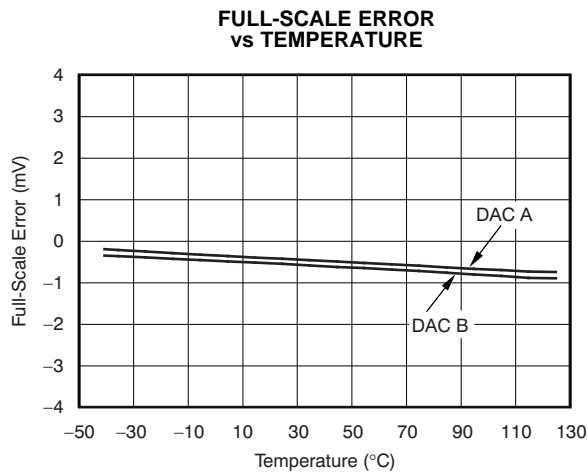


Figure 16.

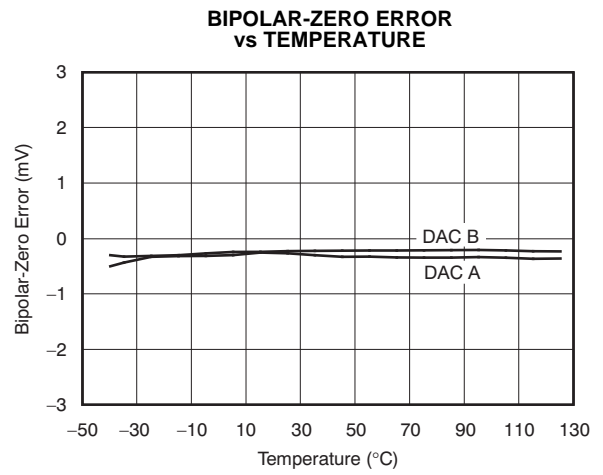


Figure 17.

TYPICAL CHARACTERISTICS: $V_{DD} = +2.7V$

Channel A

**LINEARITY ERROR
vs DIGITAL INPUT CODE**

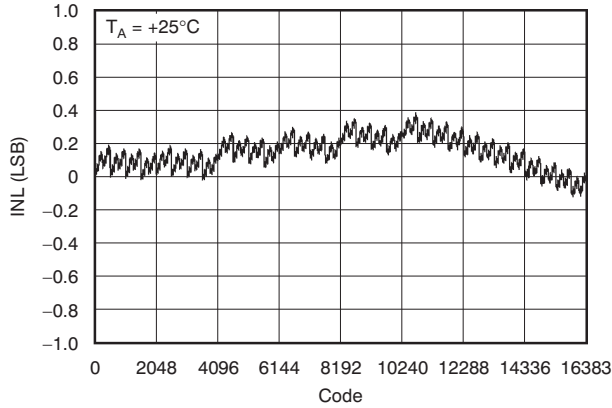


Figure 18.

**LINEARITY ERROR
vs DIGITAL INPUT CODE**

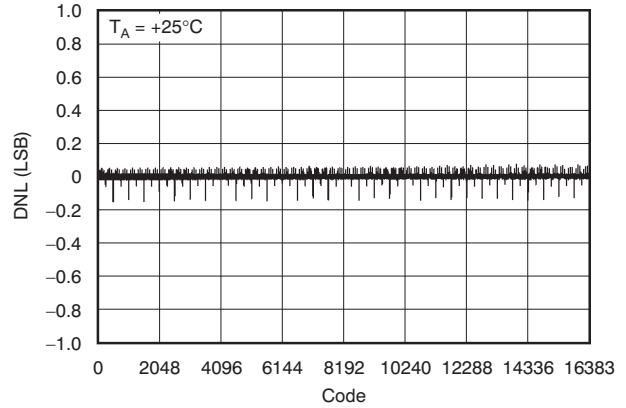


Figure 19.

**LINEARITY ERROR
vs DIGITAL INPUT CODE**

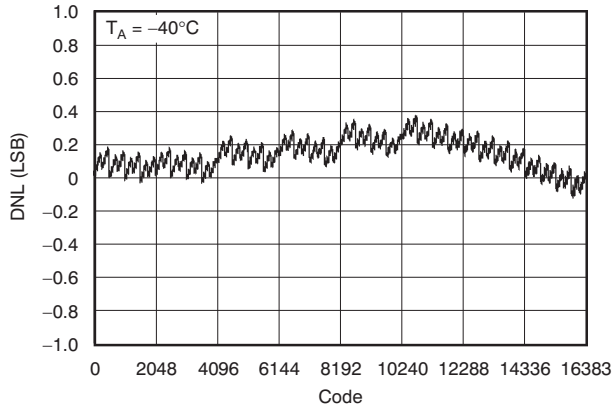


Figure 20.

**LINEARITY ERROR
vs DIGITAL INPUT CODE**

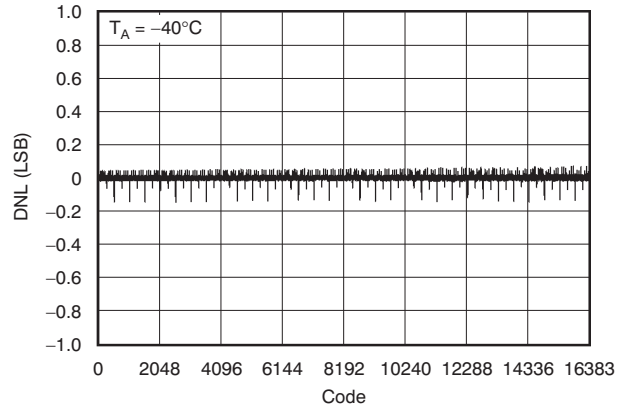


Figure 21.

**LINEARITY ERROR
vs DIGITAL INPUT CODE**

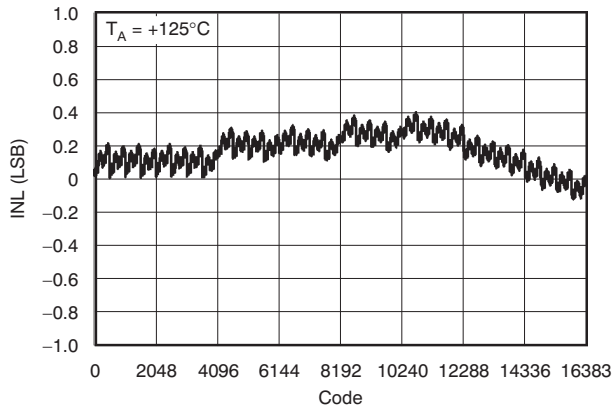


Figure 22.

**LINEARITY ERROR
vs DIGITAL INPUT CODE**

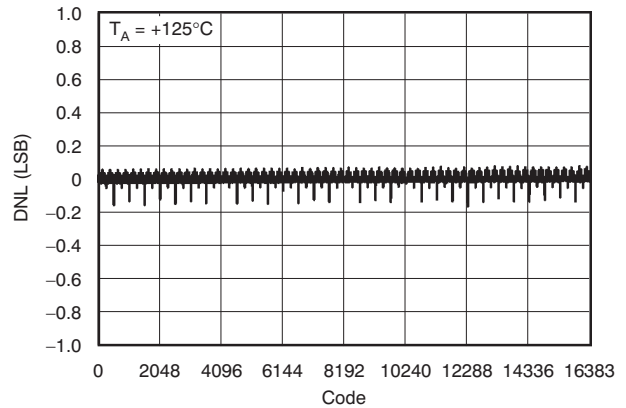


Figure 23.

TYPICAL CHARACTERISTICS: $V_{DD} = +2.7V$ (continued)

Channel B

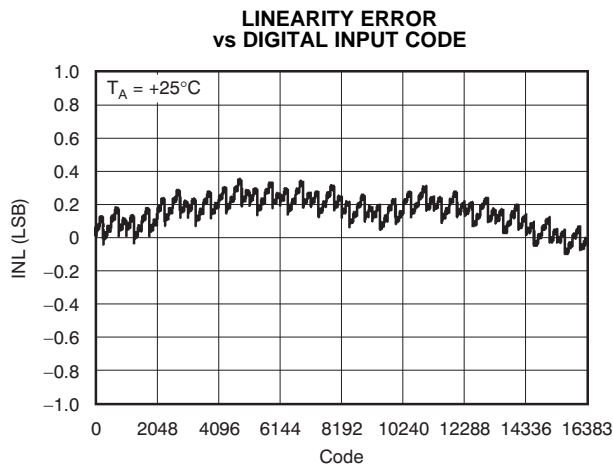


Figure 24.

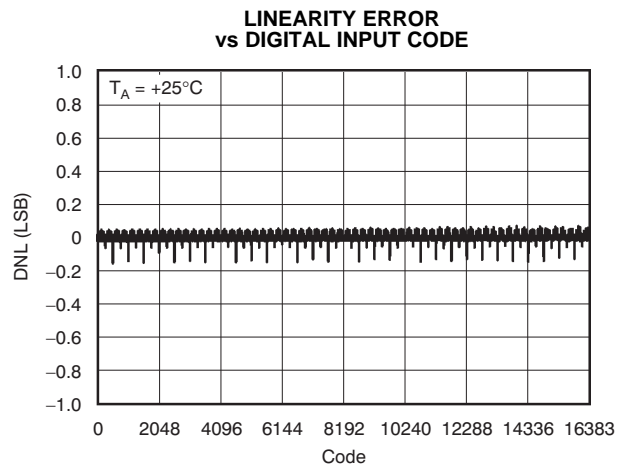


Figure 25.

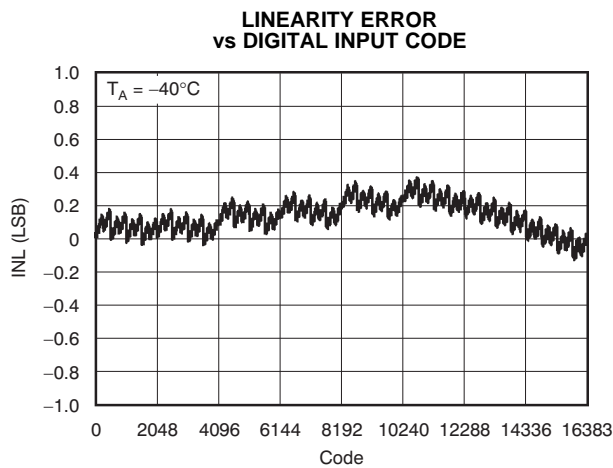


Figure 26.

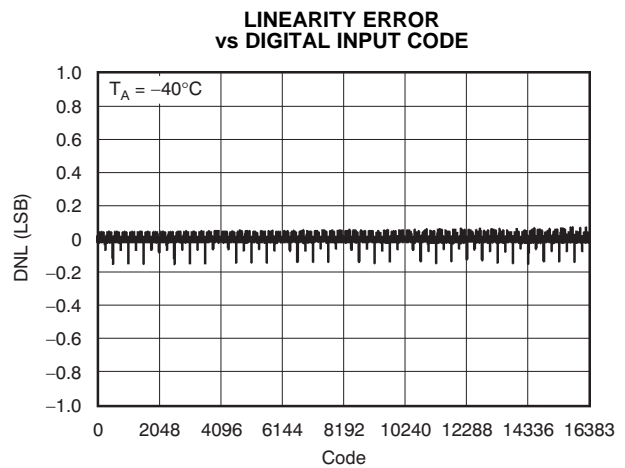


Figure 27.

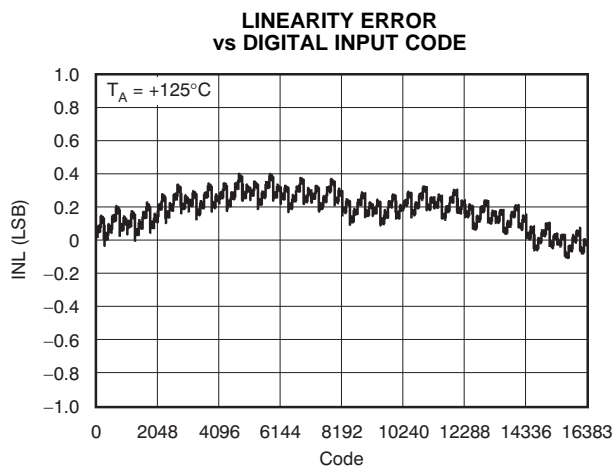


Figure 28.

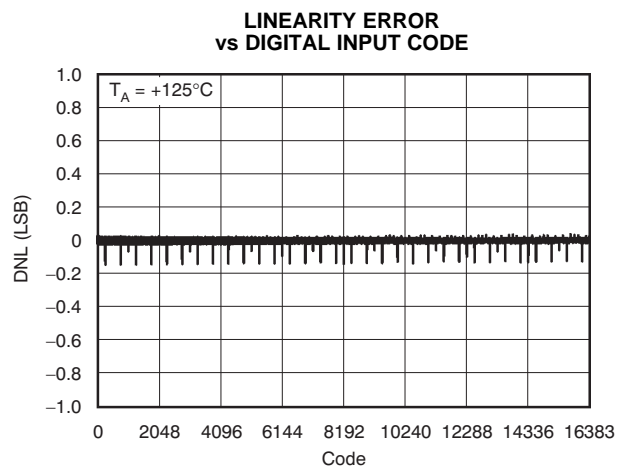


Figure 29.

TYPICAL CHARACTERISTICS: $V_{DD} = +2.7V$ (continued)

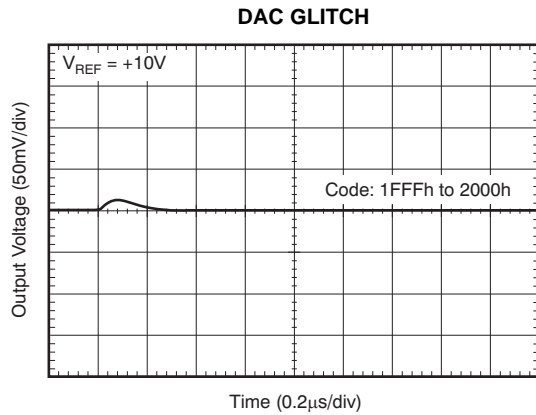


Figure 30.

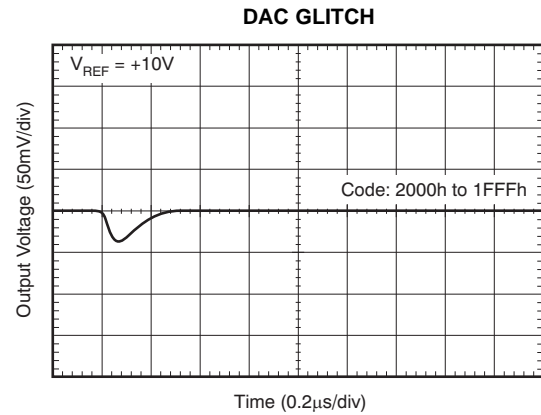


Figure 31.

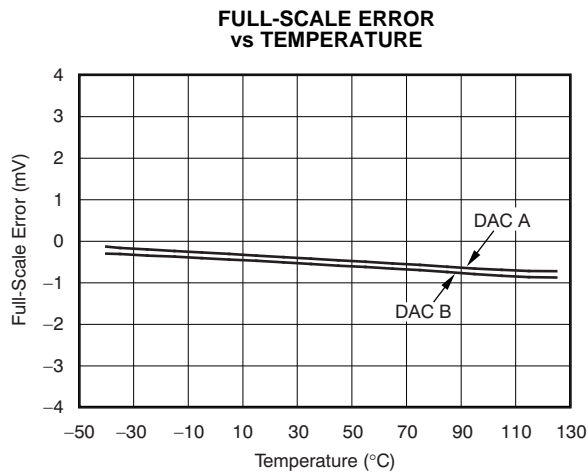


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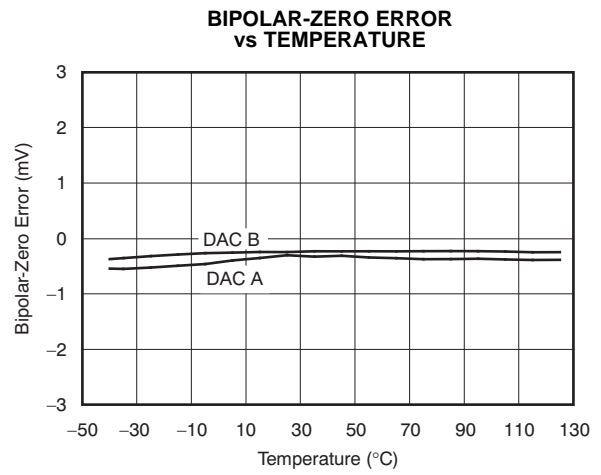


Figure 33.

TYPICAL CHARACTERISTICS: $V_{DD} = +2.7V$ and $+5V$

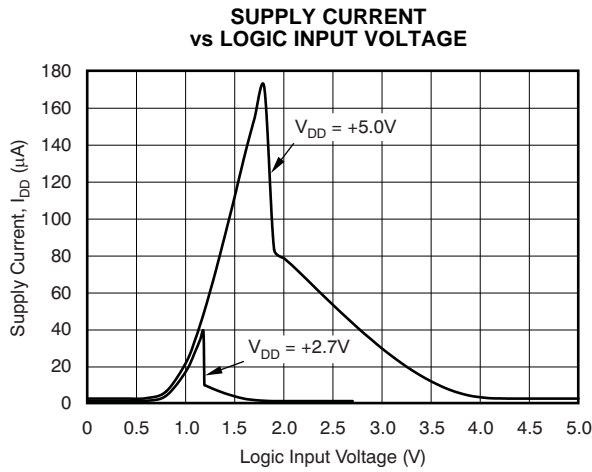


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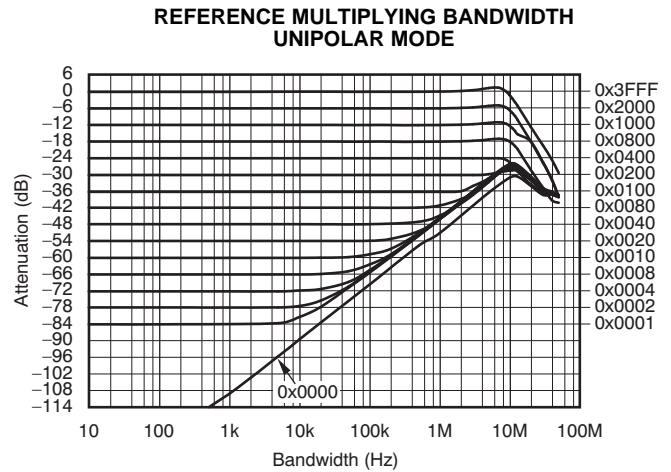


Figure 35.

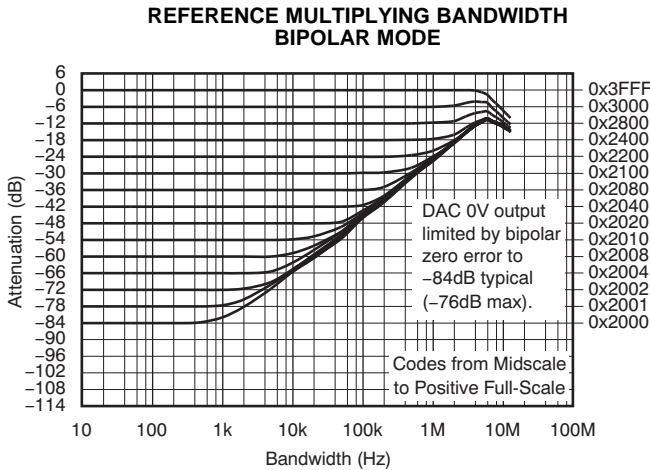


Figure 36.

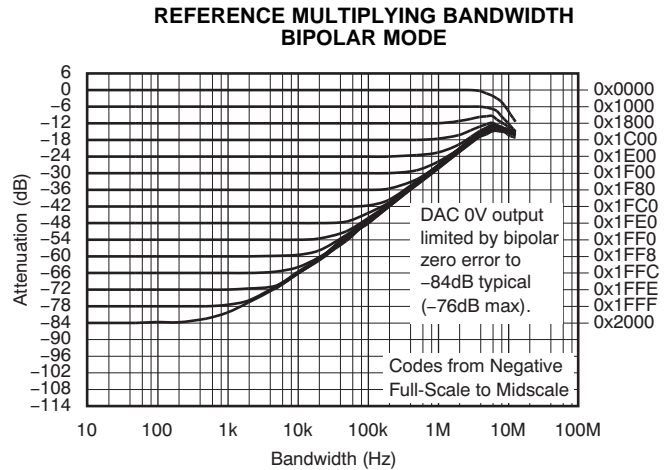


Figure 37.

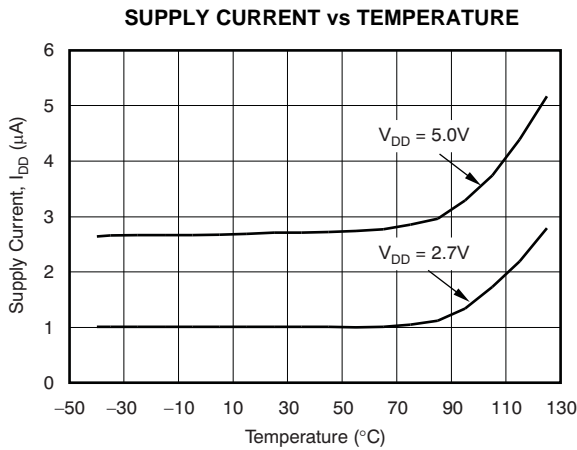


Figure 38.

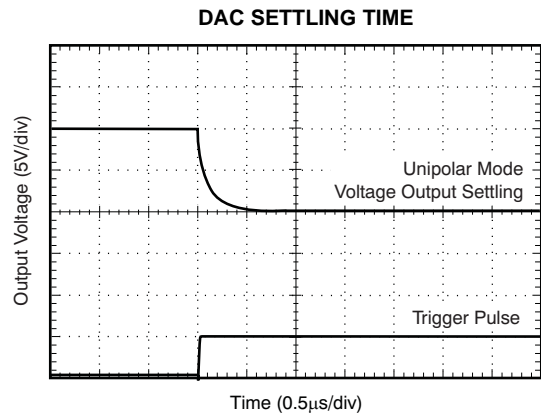


Figure 39.

THEORY OF OPERATION

The DAC8805 is a multiplying, dual-channel, current output, 14-bit DAC. The architecture, illustrated in [Figure 40](#), is an R-2R ladder configuration with the three MSBs segmented. Each 2R leg of the ladder is either switched to GND or to the I_{OUT} terminal. The I_{OUT} terminal of the DAC is held at a virtual GND potential by the use of an external I/V converter op amp. The R-2R ladder is connected to an external reference input (V_{REF}) that determines the DAC full-scale output current. The R-2R ladder presents a code-independent load impedance to the external reference of $5k\Omega \pm 25\%$. The external reference voltage can vary in a range of $-18V$ to $+18V$, thus providing bipolar I_{OUT} current operation. By using an external I/V converter op amp and the R_{FB} resistor in the DAC8805, an output voltage range of $-V_{REF}$ to $+V_{REF}$ can be generated.

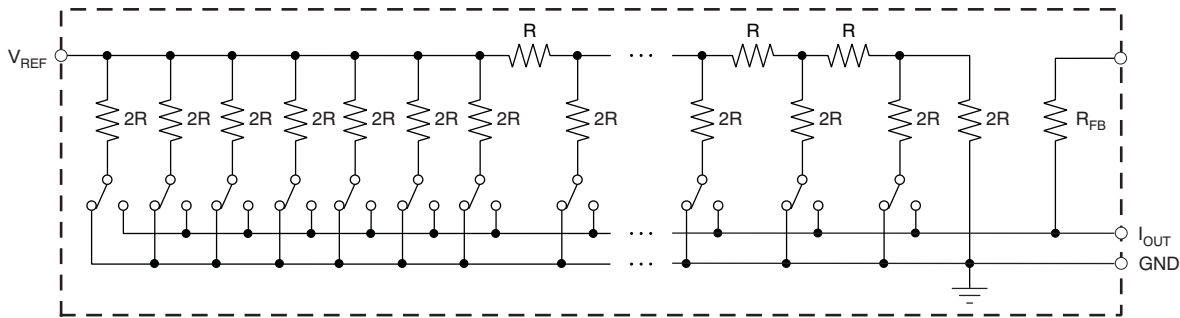


Figure 40. Equivalent R-2R DAC Circuit

The DAC output voltage is determined by V_{REF} and the digital data (D) according to [Equation 1](#):

$$V_{OUT}/B = -V_{REF} \times \frac{D}{16384} \quad (1)$$

Each DAC code determines the 2R-leg switch position to either GND or I_{OUT} . The external I/V converter op amp noise gain will also change because the DAC output impedance (as seen looking into the I_{OUT} terminal) changes versus code. Because of this change in noise gain, the external I/V converter op amp must have a sufficiently low offset voltage such that the amplifier offset is not modulated by the DAC I_{OUT} terminal impedance change. External op amps with large offset voltages can produce INL errors in the transfer function of the DAC8805 because of offset modulation versus DAC code. For best linearity performance of the DAC8805, an op amp (such as the [OPA277](#)) is recommended, as shown in [Figure 41](#). This circuit allows V_{REF} to swing from $-10V$ to $+10V$.

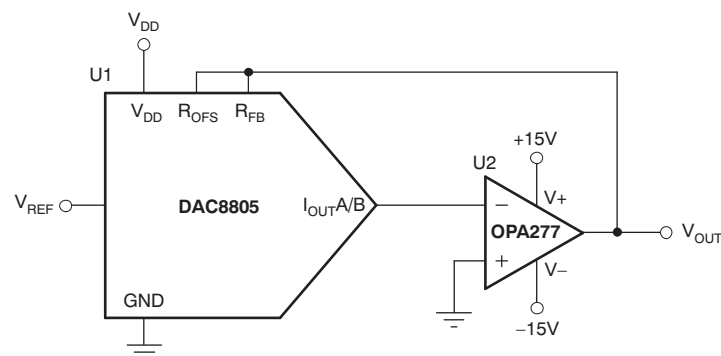


Figure 41. Voltage Output Configuration

APPLICATION INFORMATION

DIGITAL INTERFACE

The parallel bus interface of the DAC8805 is comprised of a 14-bit data bus, D0—D13, address lines A0 and A1, and a \overline{WR} control signal. Timing and control functionality are shown in [Figure 1](#), and described in [Table 2](#) and [Table 3](#). The address lines must be set up and stable before the \overline{WR} signal goes low, to prevent loading improper data to an undesired input register.

Both channels of the DAC8805 can be simultaneously updated by control of the LDAC signal, as shown in [Figure 1](#). Reset control (\overline{RS}) and reset select control (RSTSEL) signals are provided to allow user reset ability to either zero scale or midscale codes of both the input and DAC registers.

STABILITY CIRCUIT

For a current-to-voltage (I/V) design, as shown in [Figure 42](#), the DAC8805 current output (I_{OUT}) and the connection with the inverting node of the op amp should be as short as possible and laid out according to correct printed circuit board (PCB) layout design. For each code change, there is an output step function. If the gain bandwidth product (GBP) of the op amp is limited and parasitic capacitance is excessive at the inverting node, then gain peaking is possible. Therefore, a compensation capacitor C_1 (4pF to 20pF, typ) can be added to the design for circuit stability, as shown in [Figure 42](#).

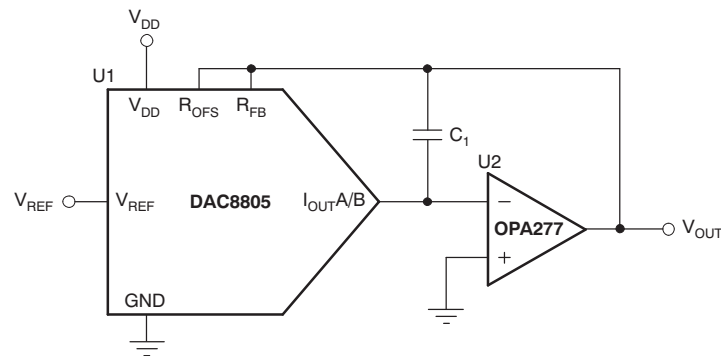


Figure 42. Gain Peaking Prevention Circuit with Compensation Capacitor

APPLICATION INFORMATION (continued)

BIPOLAR OUTPUT CIRCUIT

The DAC8805, as a 4-quadrant multiplying DAC, can be used to generate a bipolar output. The polarity of the full-scale output (I_{OUT}) is the inverse of the input reference voltage at V_{REF} .

Using a dual op amp, such as the [OPA2277](#), full 4-quadrant operation can be achieved with minimal components. [Figure 43](#) demonstrates a $\pm 10V_{OUT}$ circuit with a fixed +10V reference. The output voltage is shown in [Equation 2](#):

$$V_{OUT} = \left(\frac{D}{8192} - 1 \right) \times V_{REF} \tag{2}$$

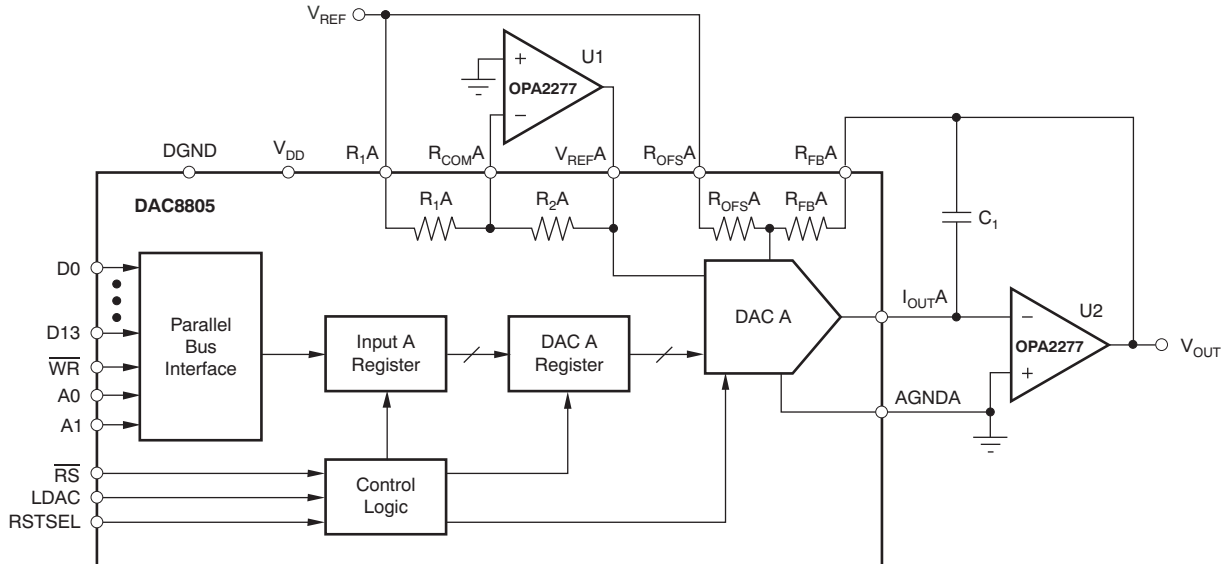


Figure 43. Bipolar Output Circuit

APPLICATION INFORMATION (continued)

PROGRAMMABLE CURRENT SOURCE CIRCUIT

The DAC8805 can be integrated into the circuit in [Figure 44](#) to implement an improved Howland current pump for precise V/I conversions. Bidirectional current flow and high-voltage compliance are two features of the circuit. With a matched resistor network, the load current of the circuit is shown by [Equation 3](#):

$$I_{L\ A/B} = \frac{(R_2 + R_3) / R_1}{R_3} \times V_{REF} \times \frac{D}{16384} \tag{3}$$

The value of R_3 in the previous equation can be reduced to increase the output current drive of U3. U3 can drive $\pm 20\text{mA}$ in both directions with voltage compliance limited up to 15V by the U3 voltage supply. Elimination of the circuit compensation capacitor (C_1) in the circuit is not suggested as a result of the change in the output impedance (Z_O), according to [Equation 4](#):

$$Z_O = \frac{R_1' R_3 (R_1 + R_2)}{R_1 (R_2' + R_3') - R_1' (R_2 + R_3)} \tag{4}$$

As shown in [Equation 4](#), Z_O with matched resistors is infinite and the circuit is optimum for use as a current source. However, if unmatched resistors are used, Z_O is positive or negative with negative output impedance being a potential cause of oscillation. Therefore, by incorporating C_1 into the circuit, possible oscillation problems are eliminated. The value of C_1 can be determined for critical applications; for most applications, however, a value of several pF is suggested.

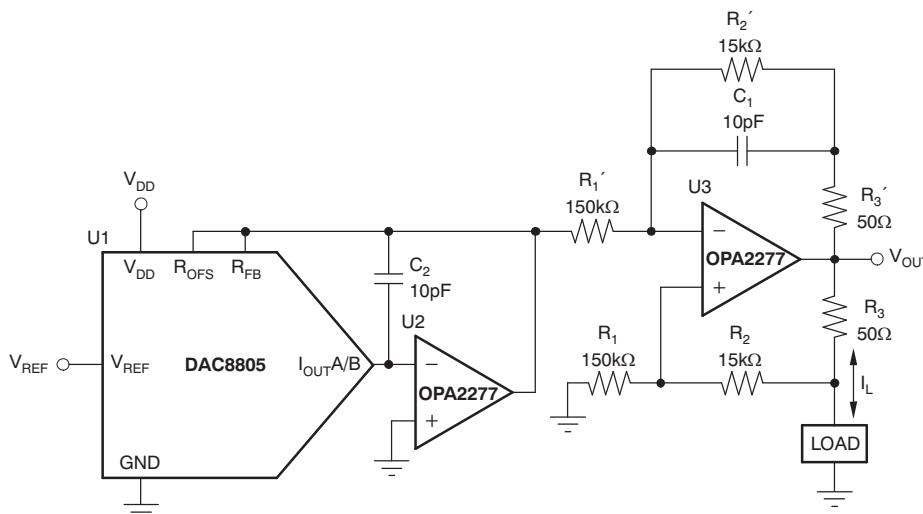


Figure 44. Programmable Bidirectional Current Source Circuit

CROSS-REFERENCE

The DAC8805 has an industry-standard pinout. [Table 4](#) provides the cross-reference information.

Table 4. Cross-Reference

| PRODUCT | BIT | INL (LSB) | DNL (LSB) | SPECIFIED TEMPERATURE RANGE | PACKAGE DESCRIPTION | PACKAGE OPTION | CROSS-REFERENCE PART |
|----------|-----|-----------|-----------|-----------------------------|---------------------|----------------|----------------------|
| DAC8805Q | 14 | 1 | 1 | -40°C to +125°C | TSSOP-38 | DBT | AD5557 |

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| DAC8805QDBT | ACTIVE | TSSOP | DBT | 38 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| DAC8805QDBTG4 | ACTIVE | TSSOP | DBT | 38 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| DAC8805QDBTR | ACTIVE | TSSOP | DBT | 38 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| DAC8805QDBTRG4 | ACTIVE | TSSOP | DBT | 38 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

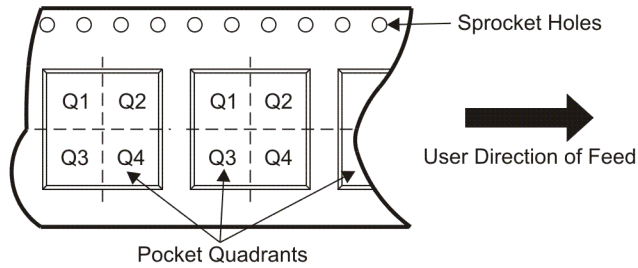
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TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| DAC8805QDBTR | TSSOP | DBT | 38 | 2000 | 330.0 | 16.4 | 6.9 | 10.2 | 1.8 | 12.0 | 16.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| DAC8805QDBTR | TSSOP | DBT | 38 | 2000 | 346.0 | 346.0 | 33.0 |

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